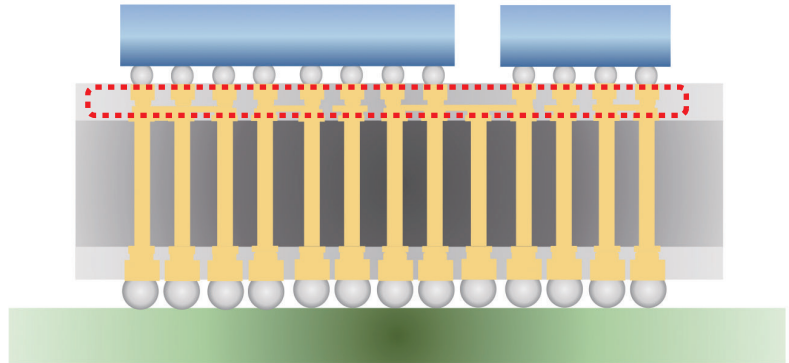
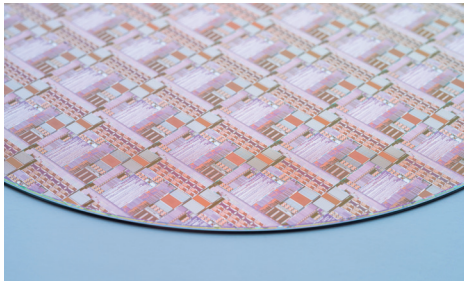
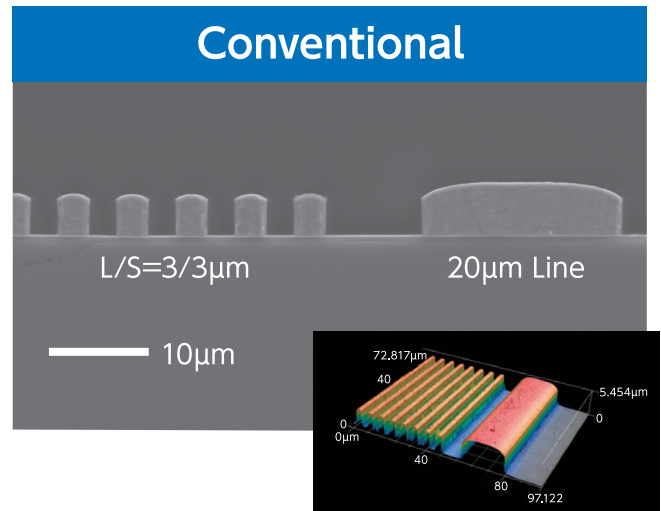
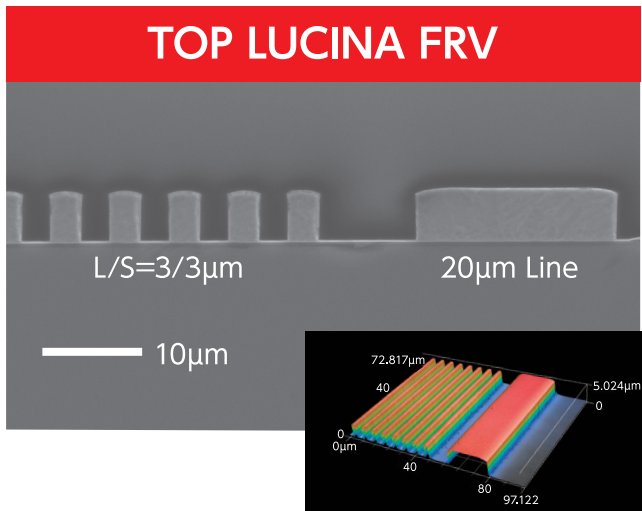


Acid copper plating additive for high aspect ratio and thickness uniformity

# TOP LUCINA FRV

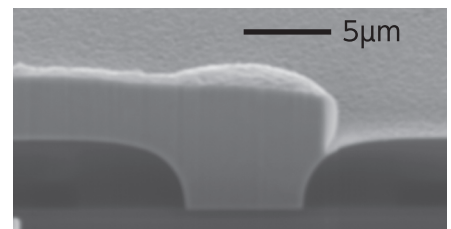
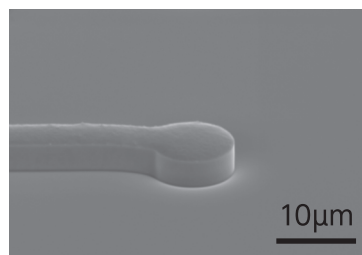
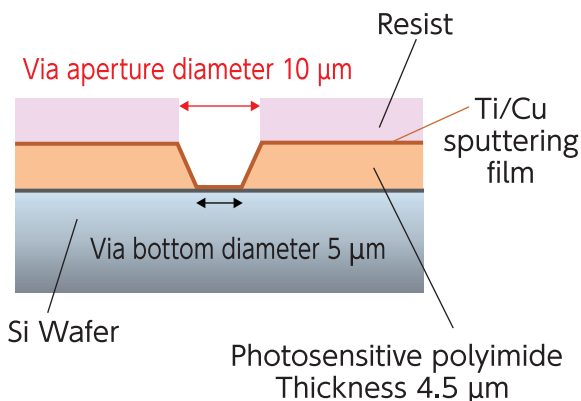


## Can form square shape pattern uniformly



Current density 1.0 A/dm<sup>2</sup>, surface thickness 5 µm

## High filling performance into micro via



Current density 1.0 A/dm<sup>2</sup>, surface thickness 5 µm